



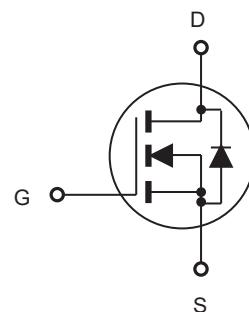
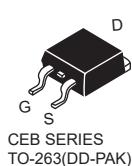
# CEP46N65SF/CEB46N65SF CEF46N65SF

N-Channel Enhancement Mode Field Effect Transistor With Fast Body Diode

## FEATURES

| Type       | $V_{DSS}@T_J \text{ max}$ | $R_{DS(\text{ON})}$ | $I_D$            | @ $V_{GS}$ |
|------------|---------------------------|---------------------|------------------|------------|
| CEP46N65SF | 700V                      | 58mΩ                | 46A              | 10V        |
| CEB46N65SF | 700V                      | 58mΩ                | 46A              | 10V        |
| CEF46N65SF | 700V                      | 58mΩ                | 46A <sup>d</sup> | 10V        |

- Super high dense cell design for extremely low  $R_{DS(\text{ON})}$ .
- High power and current handing capability.
- Pb-free lead plating ; RoHS compliant.
- Halogen Free.
- Fast reverse recovery time.



## ABSOLUTE MAXIMUM RATINGS $T_C = 25^\circ\text{C}$ unless otherwise noted

| Parameter  | Symbol         | Limit       |                                    | Units     |
|--|----------------|-------------|------------------------------------|-----------|
|  |                | TO-220/263  | TO-220F                            |           |
| Drain-Source Voltage   | $V_{DS}$       | 650         |                                    | V         |
| Gate-Source Voltage  | $V_{GS}$       | $\pm 30$    |                                    | V         |
| Drain Current-Continuous @ $T_C = 25^\circ\text{C}$<br>@ $T_C = 100^\circ\text{C}$ | $I_D$          | 46<br>29    | 46 <sup>d</sup><br>29 <sup>d</sup> | A         |
| Drain Current-Pulsed <sup>a</sup>  | $I_{DM}^e$     | 184         | 184 <sup>d</sup>                   | A         |
| Maximum Power Dissipation @ $T_C = 25^\circ\text{C}$<br>- Derate above 25°C        | $P_D$          | 305<br>2.44 | 86<br>0.69                         | W<br>W/°C |
| Single Pulsed Avalanche Energy <sup>g</sup>  | $E_{AS}$       | 380         |                                    | mJ        |
| Single Pulsed Avalanche Current <sup>g</sup>                                       | $I_{AS}$       | 4.5         |                                    | A         |
| Operating and Store Temperature Range  | $T_J, T_{stg}$ | -55 to 150  |                                    | °C        |

## Thermal Characteristics

| Parameter                               | Symbol   | Limit |      | Units |
|---|----------|-------|------|-------|
| Thermal Resistance, Junction-to-Case    | $R_{JC}$ | 0.41  | 1.46 | °C/W  |
| Thermal Resistance, Junction-to-Ambient | $R_{JA}$ | 62.5  | 65   | °C/W  |



# CEP46N65SF/CEB46N65SF CEF46N65SF

## Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

| Parameter   | Symbol                     | Test Condition   | Min | Typ  | Max  | Units            |
|---|----------------------------|--|-----|------|------|------------------|
| <b>Off Characteristics</b>                                    |                            |  |     |      |      |                  |
| Drain-Source Breakdown Voltage                                | $\text{BV}_{\text{DSS}}$   | $V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$  | 650 |      |      | V                |
| Zero Gate Voltage Drain Current                               | $I_{\text{DSS}}$           | $V_{\text{DS}} = 650\text{V}, V_{\text{GS}} = 0\text{V}$   |     |      | 5    | $\mu\text{A}$    |
| Gate Body Leakage Current, Forward                            | $I_{\text{GSSF}}$          | $V_{\text{GS}} = 30\text{V}, V_{\text{DS}} = 0\text{V}$  |     |      | 100  | nA               |
| Gate Body Leakage Current, Reverse                            | $I_{\text{GSSR}}$          | $V_{\text{GS}} = -30\text{V}, V_{\text{DS}} = 0\text{V}$   |     |      | -100 | nA               |
| <b>On Characteristics<sup>b</sup></b>                         |                            |  |     |      |      |                  |
| Gate Threshold Voltage  | $V_{\text{GS}(\text{th})}$ | $V_{\text{GS}} = V_{\text{DS}}, I_D = 250\mu\text{A}$  | 2.5 |      | 4.5  | V                |
| Static Drain-Source On-Resistance                             | $R_{\text{DS}(\text{on})}$ | $V_{\text{GS}} = 10\text{V}, I_D = 20\text{A}$   |     | 49   | 58   | $\text{m}\Omega$ |
| <b>Dynamic Characteristics<sup>c</sup></b>                    |                            |  |     |      |      |                  |
| Input Capacitance   | $C_{\text{iss}}$           | $V_{\text{DS}} = 100\text{V}, V_{\text{GS}} = 0\text{V}, f = 1.0 \text{ MHz}$                          |     | 2300 |      | pF               |
| Output Capacitance  | $C_{\text{oss}}$           |  |     | 120  |      | pF               |
| Reverse Transfer Capacitance                                  | $C_{\text{rss}}$           |  |     | 10   |      | pF               |
| <b>Switching Characteristics<sup>c</sup></b>                  |                            |  |     |      |      |                  |
| Turn-On Delay Time  | $t_{\text{d}(\text{on})}$  | $V_{\text{DD}} = 520\text{V}, I_D = 10\text{A}, V_{\text{GS}} = 10\text{V}, R_{\text{GEN}} = 10\Omega$ |     | 52   |      | ns               |
| Turn-On Rise Time   | $t_r$                      |  |     | 23   |      | ns               |
| Turn-Off Delay Time   | $t_{\text{d}(\text{off})}$ |  |     | 176  |      | ns               |
| Turn-Off Fall Time  | $t_f$                      |  |     | 9    |      | ns               |
| Total Gate Charge   | $Q_g$                      | $V_{\text{DS}} = 520\text{V}, I_D = 10\text{A}, V_{\text{GS}} = 10\text{V}$                            |     | 92   |      | nC               |
| Gate-Source Charge  | $Q_{\text{gs}}$            |  |     | 21   |      | nC               |
| Gate-Drain Charge   | $Q_{\text{gd}}$            |  |     | 37   |      | nC               |
| <b>Drain-Source Diode Characteristics and Maximum Ratings</b> |                            |  |     |      |      |                  |
| Drain-Source Diode Forward Current                            | $I_S$ <sup>f</sup>         |  |     |      | 46   | A                |
| Drain-Source Diode Forward Voltage <sup>b</sup>               | $V_{\text{SD}}$            | $V_{\text{GS}} = 0\text{V}, I_S = 20\text{A}$  |     |      | 1.5  | V                |
| Reverse Recovery Time   | $T_{\text{rr}}$            | $I_F = 20\text{A}, di/dt = 100\text{A/us}$   |     | 183  |      | ns               |
| Reverse Recovery Charge                                       | $Q_{\text{rr}}$            |  |     | 1.2  |      | uC               |
| Peak Reverse Recovery Current                                 | $I_{\text{rr}}$            |  |     | 12   |      | A                |

Notes :

- a.Repetitive Rating : Pulse width limited by maximum junction temperature .
- b.Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$  .
- c.Guaranteed by design, not subject to production testing.
- d.Limited only by maximum temperature allowed .
- e.Pulse width limited by safe operating area .
- f.Full package  $I_S(\text{max}) = 24.3\text{A}$  .  
g. $L = 37.5\text{mH}, I_{AS} = 4.5\text{A}, V_{DD} = 60\text{V}, R_G = 25\Omega$ , Starting  $T_J = 25^\circ\text{C}$ .



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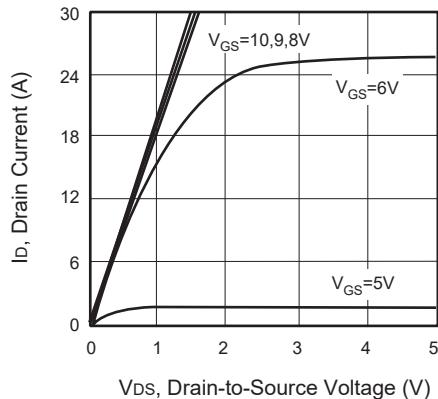


Figure 1. Output Characteristics

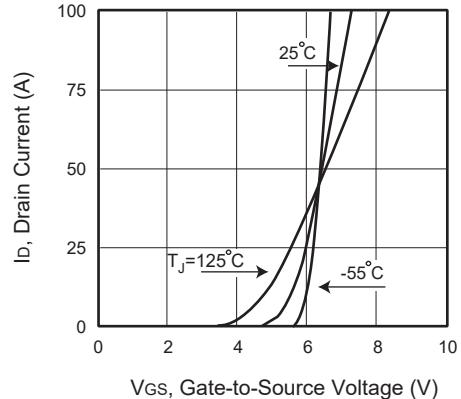


Figure 2. Transfer Characteristics

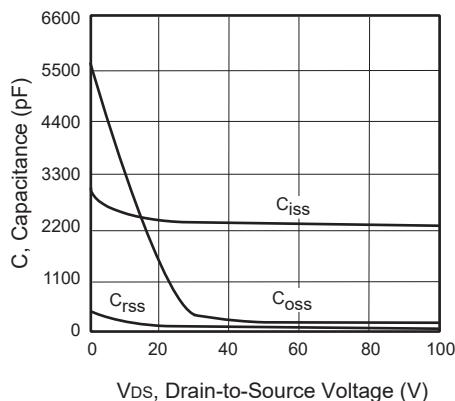


Figure 3. Capacitance

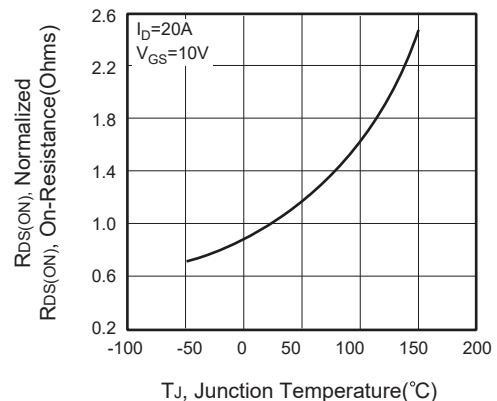


Figure 4. On-Resistance Variation with Temperature

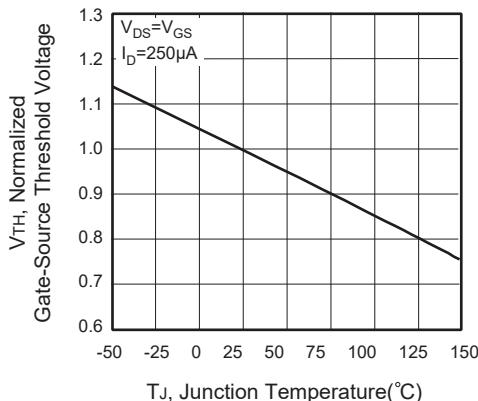


Figure 5. Gate Threshold Variation with Temperature

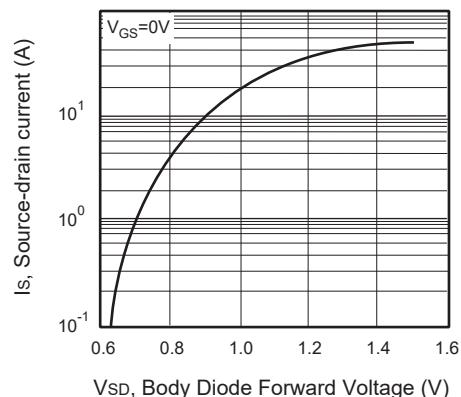


Figure 6. Body Diode Forward Voltage Variation with Source Current



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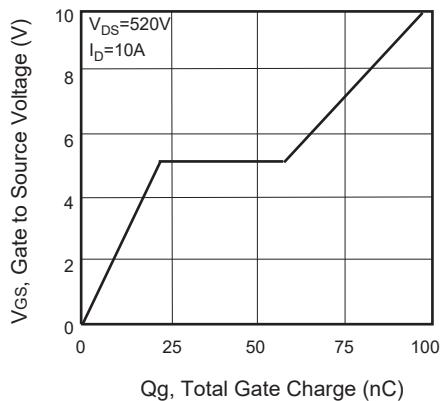


Figure 7. Gate Charge

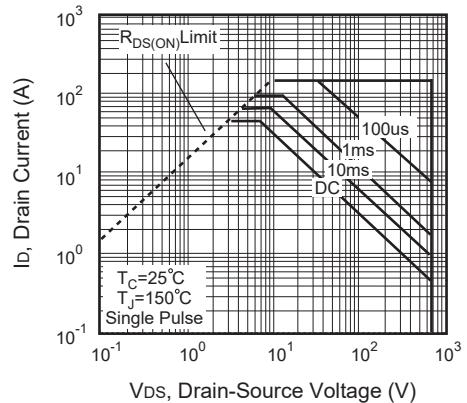


Figure 8. Maximum Safe  
Operating Area

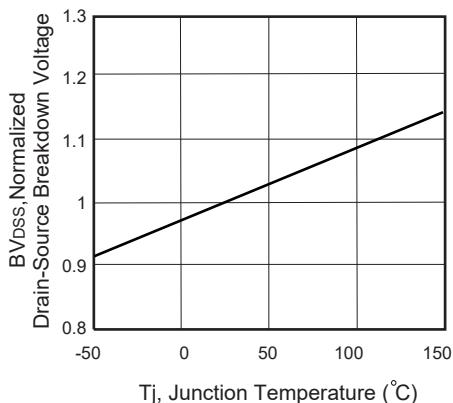


Figure 9. Breakdown Voltage Variation  
VS Temperature

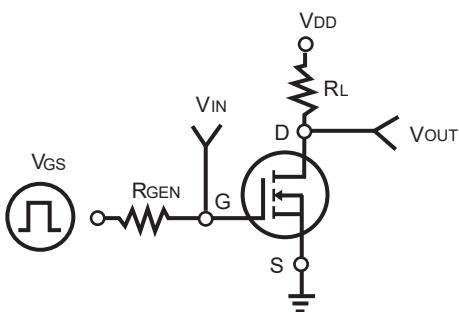


Figure 10. Switching Test Circuit

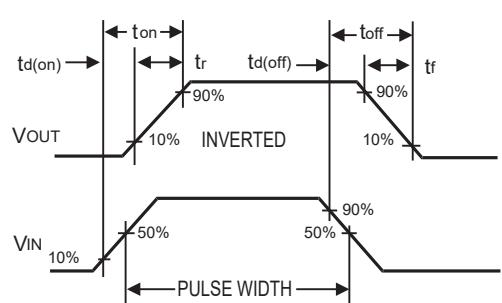


Figure 11. Switching Waveforms



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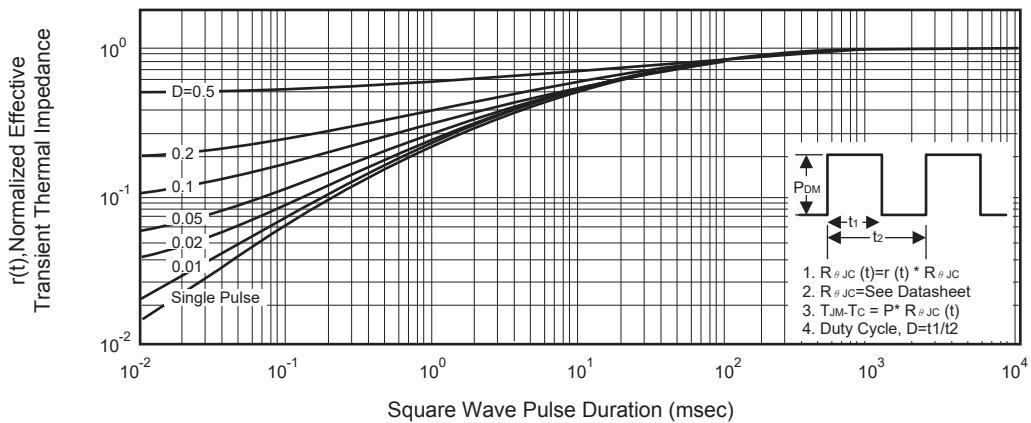


Figure 12. Normalized Thermal Transient Impedance Curve